Vishay Siliconix



Parameter	Symbol	Test Conditions		Min.	Typ. <sup>a</sup>	Max.	Unit	
Static				1				
Drain-Source Breakdown Voltage	V	V <sub>GS</sub> = 0 V, I <sub>D</sub> = 1 mA Ch-1		30			V	
	V <sub>DS</sub>	$V_{GS} = 0 V, I_{D} = 1 mA$	Ch-2	30			- V	
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Γ <sub>J</sub> I <sub>D</sub> = 250 μA C			32			
V <sub>GS(th)</sub> Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	Γ <sub>J</sub> I <sub>D</sub> = 250 μA			- 6		mV/°	
Gate Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_D = 1 \text{ mA}$	Ch-1	1		3	V	
		$V_{DS} = V_{GS}, I_D = 1 \text{ mA}$	Ch-2	1		3		
Gate-Body Leakage		$V_{DS} = 0 V, V_{GS} = \pm 20 V$	Ch-1			100	nA nA	
	I <sub>GSS</sub>	$V_{DS} = 0 V, V_{GS} = \pm 20 V$	Ch-2			100		
		$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}$	Ch-1		0.016	0.10	1	
		$V_{DS} = 30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$ Ch-2				0.001		
Zero Gate Voltage Drain Current	IDSS	$V_{DS} = 30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 100 ^{\circ}\text{C}$	Ch-1		1.1	10	mA	
		$V_{DS} = 30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 100 ^{\circ}\text{C}$	Ch-2			0.025	1	
On-State Drain Current <sup>b</sup>		$V_{DS} = 5 V, V_{GS} = 10 V$	Ch-1	20			<u> </u>	
	I <sub>D(on)</sub>	$V_{DS} = 5 V, V_{GS} = 10 V$	Ch-2	20			A	
Drain-Source On-State Resistance <sup>b</sup>	R <sub>DS(on)</sub>	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 8 \text{ A}$	Ch-1		0.0156	0.020	- Ω	
		$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 8 \text{ A}$	Ch-2		0.0156	0.020		
		$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 5 \text{ A}$	Ch-1		0.019	0.025		
		$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 5 \text{ A}$	Ch-2		0.019	0.025		
_		$V_{DS} = 15 \text{ V}, \text{ I}_{D} = 8 \text{ A}$	Ch-1		29		_	
Forward Transconductance <sup>b</sup>	9 <sub>fs</sub>	$V_{DS} = 15 \text{ V}, \text{ I}_{D} = 8 \text{ A}$ Ch-2			29		S	
Dynamic <sup>a</sup>			•		•			
Input Capacitance	C <sub>iss</sub> C <sub>oss</sub> C <sub>rss</sub>		Ch-1		950		pF	
Input Capacitance		Channel-1 $V_{-1} = 15 V V_{-1} = 0 V f = 1 MHz$	Ch-2		950			
Output Capacitance		$V_{DS} = 15 \text{ V}, V_{GS} = 0 \text{ V}, \text{ f} = 1 \text{ MHz}$	Ch-1		185			
Output Capacitance		Channel-2	Ch-2		155			
Reverse Transfer Capacitance		$V_{DS}$ = 15 V, $V_{GS}$ = 0 V, f = 1 MHz	Ch-1		65			
			Ch-2		65			
Total Gate Charge	Qg	$V_{DS} = 15 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 8 \text{ A}$	Ch-1		16.5	25		
		$V_{DS} = 15 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 8 \text{ A}$	Ch-2		16.5	25	nC	
		Channel-1	Ch-1		7.3	11		
		$V_{DS} = 15 \text{ V}, V_{GS} = 4.5 \text{ V}, I_D = 8 \text{ A}$	Ch-2		7.3	11		
Gate-Source Charge	Q <sub>gs</sub>		Ch-1		2.7			
Gate-Drain Charge	Q <sub>gd</sub>	Channel-2	Ch-2		2.7			
		$V_{DS} = 15 \text{ V}, \text{ V}_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 8 \text{ A}$	Ch-1		2.1			
	R <sub>g</sub>		Ch-2	0.0	2.1	0.4	<u> </u>	
Gate Resistance		f = 1 MHz	Ch-1	0.2	1.2	2.4	Ω	

Notes:

a. Guaranteed by design, not subject to production testing.

b. Pulse test; pulse width  $\leq$  300  $\mu s,$  duty cycle  $\leq$  2 %.



# Si4834CDY Vishay Siliconix

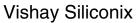
Parameter	Symbol	Test Conditions		Min.	Typ. <sup>a</sup>	Max.	Unit
Dynamic <sup>a</sup>		•					
Turn-On Delay Time	t <sub>d(on)</sub>	Channel-1	Ch-1		10	20	
	u(on)	$V_{DD} = 15 \text{ V}, \text{ R}_{I} = 3 \Omega$	Ch-2		9	18	
Rise Time		Ch-1		10	20		
			Ch-2		11 18	20 35	ns
Turn-Off Delay Time	t <sub>d(off)</sub>	Channel-2	Ch-1 Ch-2		18	35	
		$V_{DD} = 15 V, R_L = 3 \Omega$	Ch-1		9	18	
Fall Time	t <sub>f</sub>	$I_D \cong$ 5 A, $V_{GEN}$ = 10 V, $R_g$ = 1 $\Omega$	Ch-2		8	16	
		Channel-1	Ch-1		17	35	
Turn-On Delay Time	t <sub>d(on)</sub>		Ch-2		17	35	
Rise Time	t <sub>r</sub>	$V_{DD} = 15 \text{ V}, \text{ R}_{L} = 3 \Omega$	Ch-1		12	24	
		$I_D \cong 5$ A, $V_{GEN}$ = 4.5 V, $R_g$ = 1 $\Omega$	Ch-2		12	24	
Turn-Off Delay Time	t <sub>d(off)</sub>	Channel-2 V <sub>DD</sub> = 15 V, R <sub>L</sub> = 3 $\Omega$	Ch-1		19	35	
			Ch-2		18	35	
Fall Time		$\text{I}_\text{D}\cong$ 5 A, $\text{V}_\text{GEN}$ = 4.5 V, $\text{R}_\text{g}$ = 1 $\Omega$	Ch-1		10	20	
	•		Ch-2		10	20	
Drain-Source Body Diode Characteristic	s			[	1		1
Continuous Source-Drain Diode Current	۱ <sub>S</sub>	T <sub>C</sub> = 25 °C	Ch-1			2.6	- A
			Ch-2			2.6 30	
Pulse Diode Forward Current <sup>a</sup>	I <sub>SM</sub>		Ch-1 Ch-2			30	
Body Diode Voltage	V <sub>SD</sub>	I <sub>S</sub> = 1 A	Ch-1		0.46	0.51	v
		$I_{S} = 1 A$	Ch-2		0.40	1.1	
		.5	Ch-1		17	34	
Body Diode Reverse Recovery Time			Ch-2		17	34	ns
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>	Channel-1	Ch-1		7	14	nC
		$I_F = 5 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, \text{ T}_J = 25 ^\circ\text{C}$	Ch-2		9	18	
Reverse Recovery Fall Time	t <sub>a</sub>	Channel-2	Ch-1		9		
		$I_F = 5 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 \text{ °C}$	Ch-2		10		- ns
Reverse Recovery Rise Time	t <sub>b</sub>		Ch-1		8		
Reverse Recovery Rise Time			Ch-2		7		

Notes:

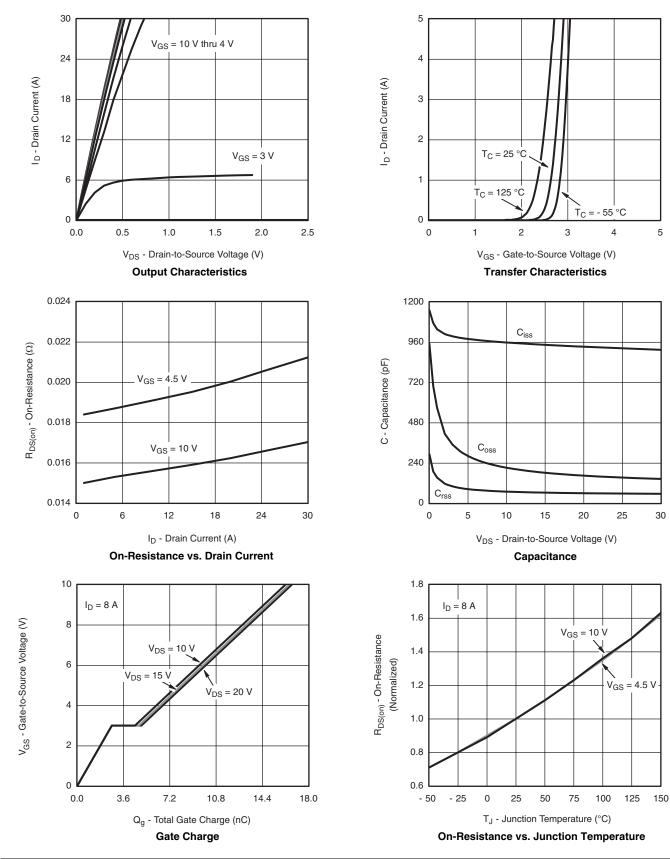
a. Guaranteed by design, not subject to production testing.

b. Pulse test; pulse width  $\leq$  300  $\mu s,$  duty cycle  $\leq$  2 %.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



#### CHANNEL-1 TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



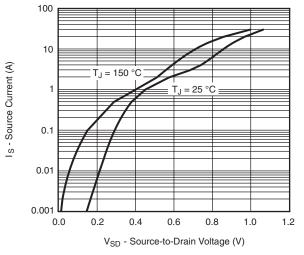
www.vishay.com 4



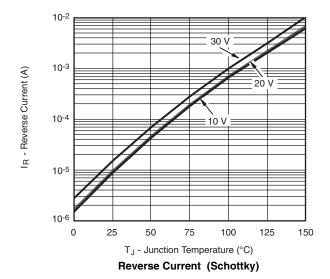


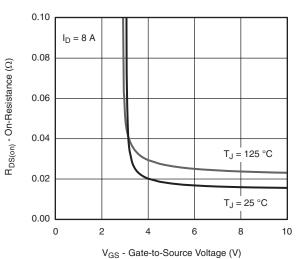
Vishay Siliconix



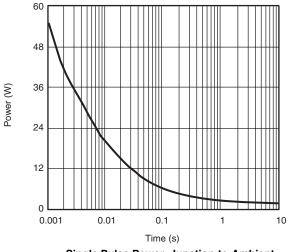




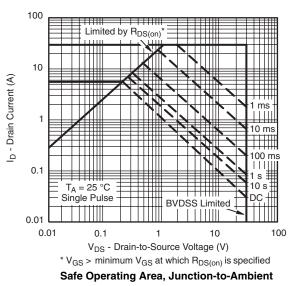




On-Resistance vs. Gate-to-Source Voltage



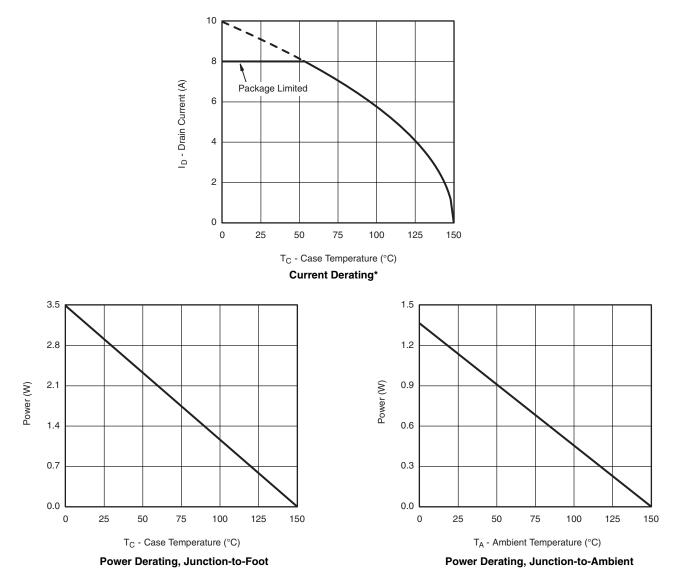
Single Pulse Power, Junction-to-Ambient



Document Number: 68790 S09-2109-Rev. B, 12-Oct-09

### Vishay Siliconix

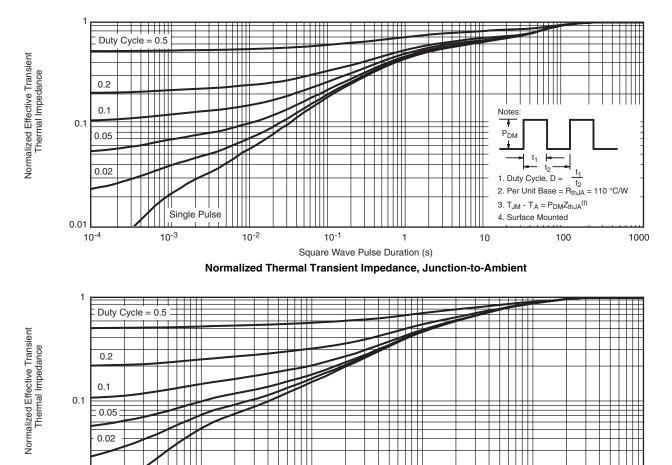




\* The power dissipation  $P_D$  is based on  $T_{J(max)} = 150$  °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

/ISHAY





#### CHANNEL-1 TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Foot

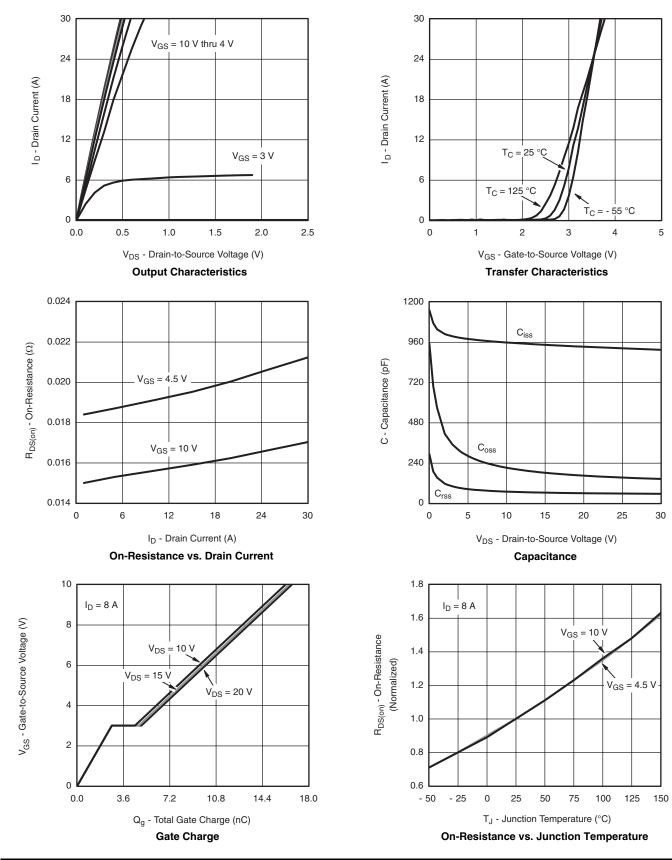
0.01

Single Pulse

10



#### CHANNEL-2 TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



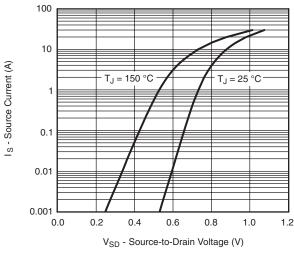
www.vishay.com 8



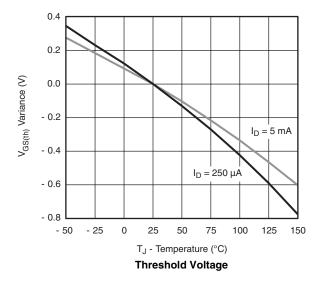


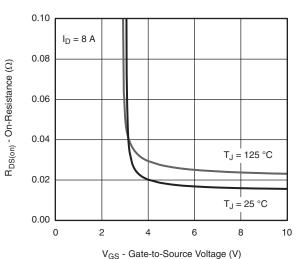
Vishay Siliconix

#### CHANNEL-2 TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

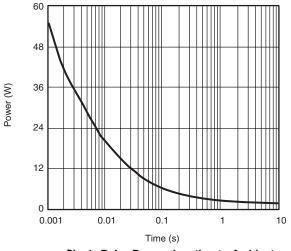




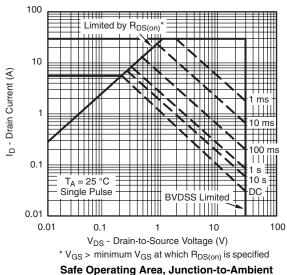




On-Resistance vs. Gate-to-Source Voltage



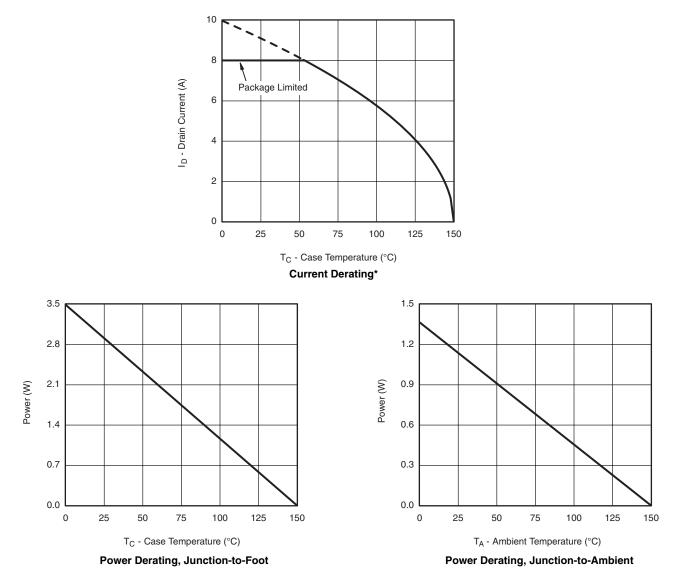
Single Pulse Power, Junction-to-Ambient



Document Number: 68790 S09-2109-Rev. B, 12-Oct-09

### Vishay Siliconix



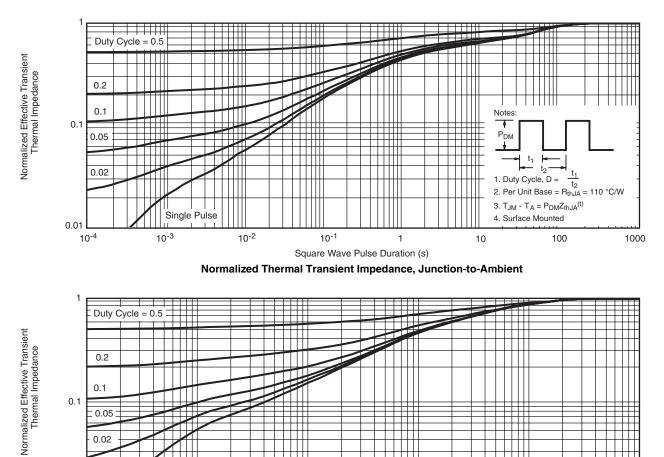


\* The power dissipation  $P_D$  is based on  $T_{J(max)} = 150$  °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

/ISHAY



### Si4834CDY Vishay Siliconix



#### CHANNEL-2 TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

Square Wave Pulse Duration (s) Normalized Thermal Transient Impedance, Junction-to-Foot

10-2

10-1

1

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <a href="http://www.vishay.com/ppg268790">www.vishay.com/ppg268790</a>.

Document Number: 68790 S09-2109-Rev. B, 12-Oct-09

0.1

0.05

0.02

Single Pulse

10<sup>-3</sup>

0.1

0.01 10-4

10

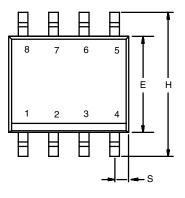


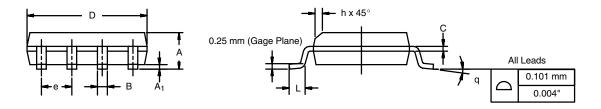
### Package Information

Vishay Siliconix

#### SOIC (NARROW): 8-LEAD

JEDEC Part Number: MS-012





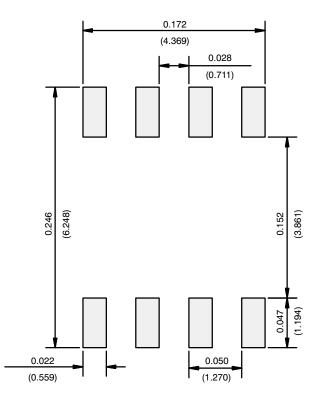
	MILLIM	IETERS	INCHES				
DIM	Min	Мах	Min	Max			
A	1.35	1.75	0.053	0.069			
A <sub>1</sub>	0.10	0.20	0.004	0.008			
В	0.35	0.51	0.014	0.020			
С	0.19	0.25	0.0075	0.010			
D	4.80	5.00	0.189	0.196			
E	3.80	4.00	0.150	0.157			
е	1.27 BSC		0.050 BSC				
н	5.80	6.20	0.228	0.244			
h	0.25	0.50	0.010	0.020			
L	0.50	0.93	0.020	0.037			
q	0°	8°	0°	8°			
S	0.44	0.64	0.018	0.026			
ECN: C-06527-Rev. I, 11-Sep-06 DWG: 5498							

### **Application Note 826**

Vishay Siliconix



**RECOMMENDED MINIMUM PADS FOR SO-8** 



Recommended Minimum Pads Dimensions in Inches/(mm)

Return to Index

www.vishay.com 22



Vishay

### Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and / or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.